

MX0141KA1AVW

1:4 High-Speed Memory Bus MUX

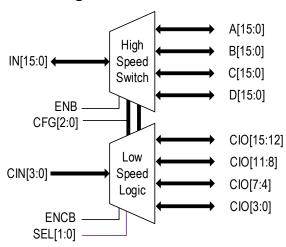
The MX0141KA1AVW is 1:4 high-speed MUX that is comprised of a high-speed 1:4 multiplexer (mux) path and a low speed multi-function control logic path.

The high-speed path consists of four passive switches that connects input port IN to four output ports A, B, C, and D. Each ports is 16-bit. The passive switches, which closed selectively, form a bidirectional multiplexer.

The low-speed path consists of active multi-function IOs that can be configured in different modes. This path also can be configured as unidirectional 1:4 mux with a 4-bit port width, 4:16 decoder, or 16-bit signals for port selection. The CIO pins can be used to drive Chip Enable pins of the NAND dies or high-speed mux selector.

Both high-speed and low-speed paths support SSTL_12 and SSTL_18 signaling.

Block Diagram



Typical Applications

- SSD drive memory expansion or load reduction for both ONFI3/4 and TOGGLE NAND Flash system
- General-purpose bus 1:4 multiplexer for highspeed, low-power product solutions

Main Features

- · 1:4 high bandwidth 16 bit bus multiplexer
- SSTL18 and SSTL12 signaling
- 4 x 11 mm FCCSP package with 0.65/0.5mm ball pitch

High-Speed MUX Features

- · Bidirectional passive port switches
- Pull-up/Pull-down/Tristate/bus-hold for deselected ports
- Pin-to-pin output skew < 30ps (within a port)
- Pin-to-pin output skew < 10ps (Differential pairs)
- Propagation delay < 150ps
- Insertion loss < 1dB at 800MHz
- Bus holding, weak pull-down, or weak pull-up for deselected ports in different configurations via the CFG pins

Low-Speed MUX/Control Logic Features

- 4-bit in, 16-bit input/output logic targeted for Chip Enables or port selections
- Multiplexing or decoding
- · Unidirectional, active multiplexing
- · Multiple function selected via the CFG pins

Table 1. Characteristics of High-Speed Paths

Feature	High-Speed Path
Port speed	Up to 1600MT/s
Port size	16-bit
Direction	Bidirectional IN \longleftrightarrow A, B, C, or D
Control pins	SEL[1:0], ENB, ENCB, CIN[3:0], CIO[15:0]
Signaling through port	SSTL_12, SSTL_18

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01 Jan 2024)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit www.renesas.com/contact-us/.